Octal buffer/driver with parity, non-inverting (3-State) 74F456

FEATURES

- High impedance NPN base inputs for reduced loading (40μA in High and Low states)
- 74F456 combines 74F244 and 74F280A functions in one package
- 74F456 is a center pin version of the 74F656A
- Non-Inverting
- 3-State outputs sink 64mA and source 15mA
- 24-pin plastic Slim DIP (300 mil) package
- Broadside pinout simplifies PC board layout

DESCRIPTION

The 74F456 is an octal buffer and line driver with parity generation/checking designed to be employed as memory address drivers, clock drivers and bus-oriented transmitters/receivers. These parts include parity generator/checker to improve PC board density.

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F456	7.5ns	64mA

ORDERING INFORMATION

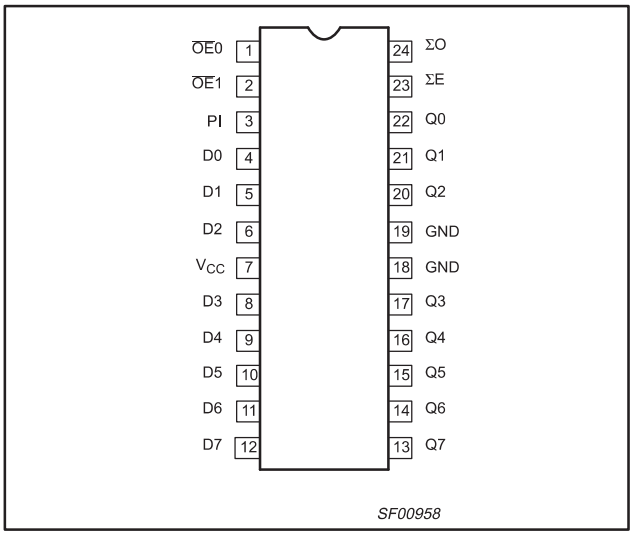
DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V ±10%, T_{amb} = 0°C to +70°C	PKG DWG #
24-pin plastic Slim DIP (300mil)	N74F456N	SOT222-1
24-pin plastic SOL	N74F456D	SOT137-1

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

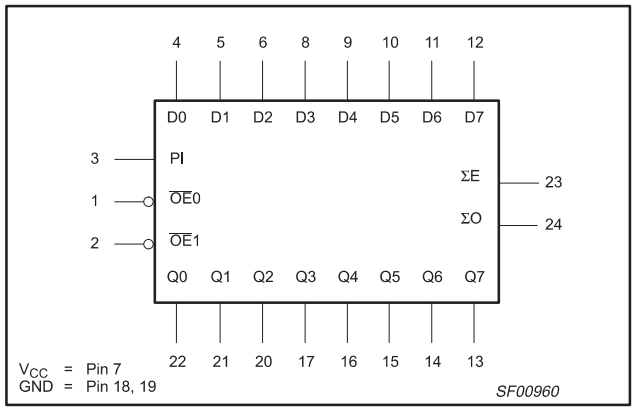
PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
D0–D7	Data inputs	2.0/0.066	40μA/40μA
PI	Parity input	1.0/0.033	20μA/20μA
$\overline{OE}0$, $\overline{OE}1$	Output Enable inputs (active Low)	1.0/0.033	20μA/20μA
ΣE, ΣO	Parity outputs	750/106.7	15mA/64mA
Q0–Q7	Data outputs	750/106.7	15mA/64mA

NOTE: One (1.0) FAST Unit Load (U.L.) is defined as 20μA in the High state and 0.6mA in the Low state.

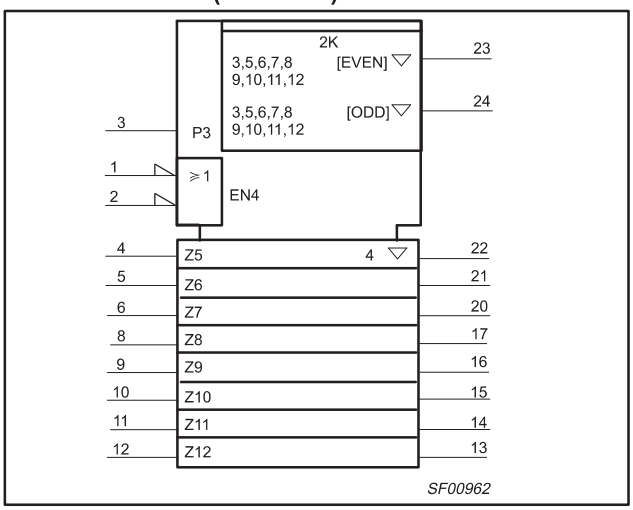
PIN CONFIGURATION



LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLE

INPUTS			OUTPUTS
$\overline{OE}0$	$\overline{OE}1$	Dn	Qn
L	L	L	L
L	L	H	H
H	X	X	Z
X	H	X	Z

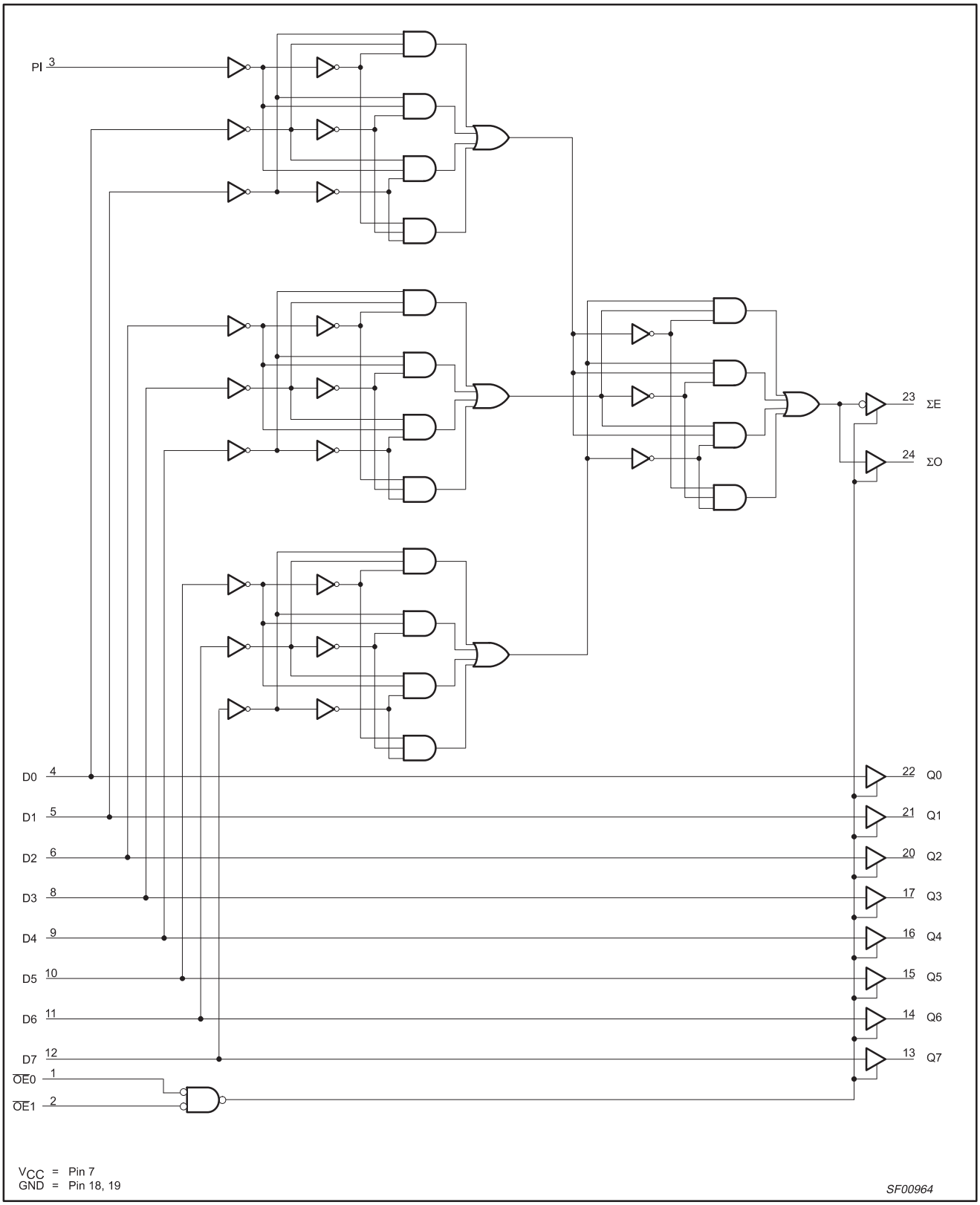
H = High voltage level
L = Low voltage level
Z = High impedance “off” state
X = Don’t care

FUNCTION TABLE for PARITY OUTPUTS

INPUTS	OUTPUTS	
Number of inputs, High (PI, D0 - D7)	ΣE	ΣO
Even - 0, 2, 4, 6, 8	H	L
Odd - 1, 3, 5, 7, 9	L	H
Any $\overline{OE}$n = High	Z	Z

H = High voltage level
L = Low voltage level
Z = High impedance “off” state
X = Don’t care

LOGIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device.
Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V_{CC}	Supply voltage	–0.5 to +7.0	V
V_{IN}	Input voltage	–0.5 to +7.0	V
I_{IN}	Input current	–30 to +5	mA
V_{OUT}	Voltage applied to output in High output state	–0.5 to +V_{CC}	V
I_{OUT}	Current applied to output in Low output state	128	mA
T_{amb}	Operating free-air temperature range	0 to +70	°C
T_{stg}	Storage temperature range	–65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS			UNIT
		MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5.0	5.5	V
V_{IH}	High-level input voltage	2.0			V
V_{IL}	Low-level input voltage			0.8	V
I_{IK}	Input clamp current			–18	mA
I_{OH}	High-level output current			–15	mA
I_{OL}	Low-level output current			64	mA
T_{amb}	Operating free-air temperature range	0		70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIONS[1]			LIMITS			UNIT
						MIN	TYP[2]	MAX	
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN	I_{OH}=–3mA	±10%V_{CC}	2.4			V
					±5%V_{CC}	2.7	3.3		V
				I_{OH} =–15mA	±10%V_{CC}	2.0			V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IL} = MAX, V_{IH} = MIN	I_{OL} = MAX	±10%V_{CC}			0.55	V
					±5%V_{CC}		0.42	0.55	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = I_{IK}				–0.73	–1.2	V
I_I	Input current at maximum input voltage		V_{CC} = 0.0V, V_I = 7.0V					100	µA
I_{IH}	High-level input current	Dn	V_{CC} = MAX, V_I = 2.7V					40	µA
		PI, $\overline{OE}$n						20	µA
I_{IL}	Low-level input current	Dn	V_{CC} = MAX, V_I = 0.5V					–40	µA
		PI, $\overline{OE}$n						–20	µA
I_{OZH}	Off-state output current High-level voltage applied		V_{CC} = MAX, V_O = 2.7V					50	µA
I_{OZL}	Off-state output current Low-level voltage applied		V_{CC} = MAX, V_O = 0.5V					–50	µA
I_{OS}	Short-circuit output current[3]		V_{CC} = MAX			–100		–225	mA
I_{CC}	Supply current (total)	I_{CCH}	V_{CC} = MAX				50	80	mA
		I_{CCL}					78	110	mA
		I_{CCZ}					63	90	mA

NOTES:

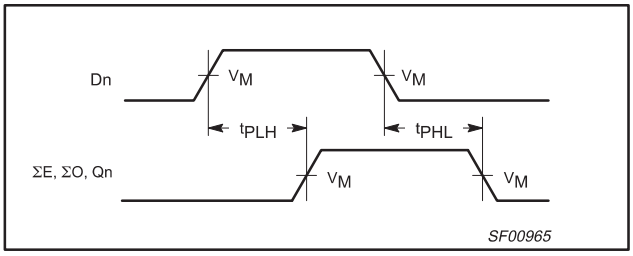
1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
2. All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
3. Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

AC ELECTRICAL CHARACTERISTICS

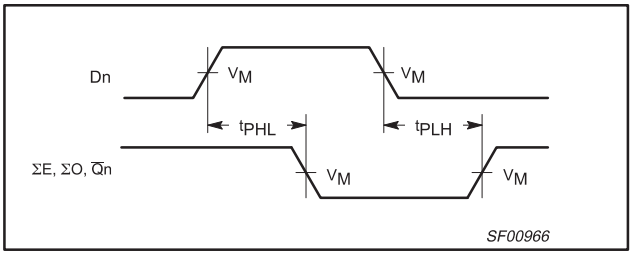
SYMBOL	PARAMETER	TEST CONDITION	LIMITS					UNIT
			V_{CC} = +5V T_{amb} = +25°C C_L = 50pF, R_L = 500Ω			V_{CC} = +5V ± 10% T_{amb} = 0°C to +70°C C_L = 50pF, R_L = 500Ω		
			MIN	TYP	MAX	MIN	MAX	
t_{PLH} t_{PHL}	Propagation delay Dn to Qn	Waveform 1	2.0 2.5	4.5 5.0	6.5 7.0	2.0 2.5	7.0 7.5	ns
t_{PLH} t_{PHL}	Propagation delay Dn to ΣE, ΣO	Waveform 1, 2	5.5 5.5	10.0 11.0	13.0 14.5	5.5 5.5	14.0 16.5	ns
t_{PZH} t_{PZL}	Output Enable time to High or Low level	Waveform 3 Waveform 4	2.5 4.0	4.0 8.0	8.0 10.5	2.5 4.0	9.0 11.5	ns
t_{PHZ} t_{PLZ}	Output Disable time from High or Low level	Waveform 3 Waveform 4	1.5 2.0	4.0 5.0	6.5 7.5	1.5 2.0	7.5 8.0	ns

AC WAVEFORMS

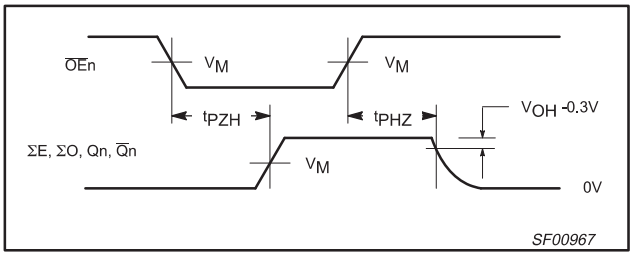
For all waveforms, V_M = 1.5V.



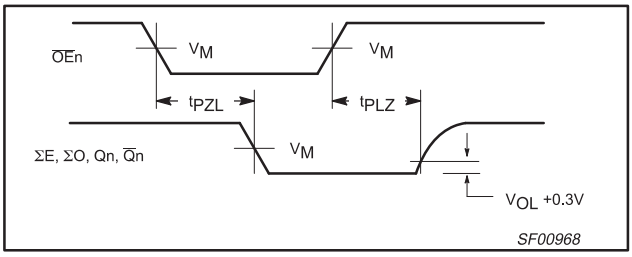
Waveform 1. Propagation Delay, Non-Inverting Outputs



Waveform 2. Propagation Delay, Inverting Outputs

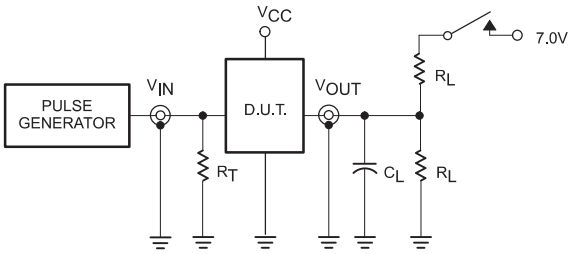


Waveform 3. 3-State Output Enable Time to High Level and Output Disable Time from High Level

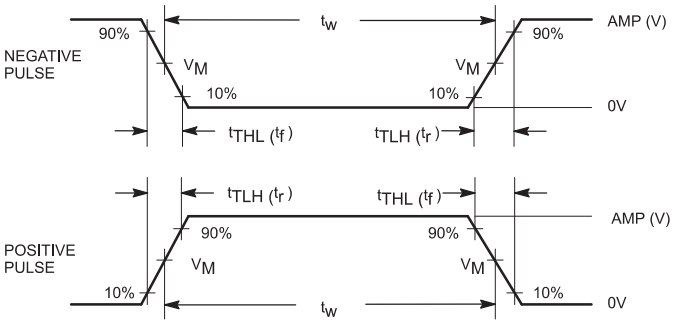


Waveform 4. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

TEST CIRCUIT AND WAVEFORMS



Test Circuit for 3-State Outputs



Input Pulse Definition

SWITCH POSITION

TEST	SWITCH
t_{PLZ}	closed
t_{PZL}	closed
All other	open

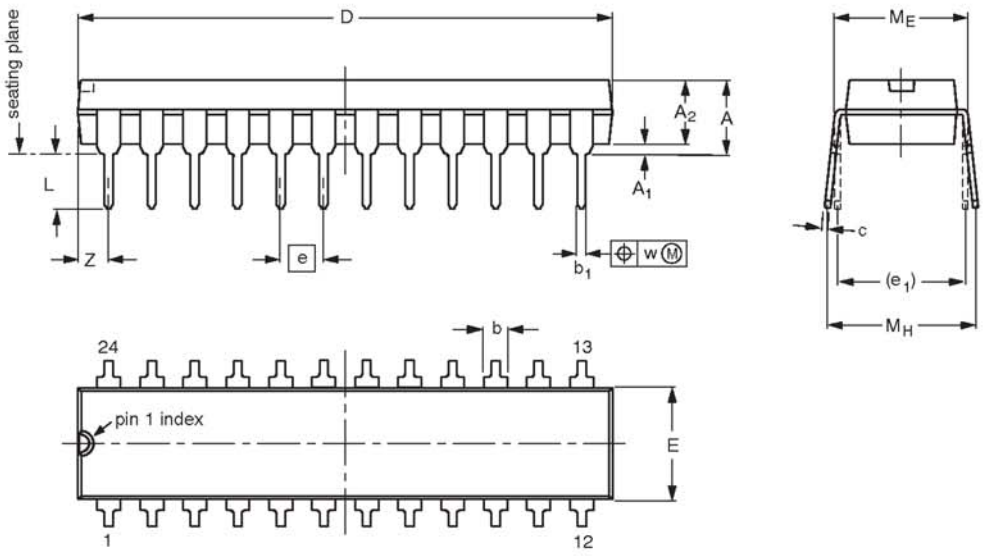
DEFINITIONS:

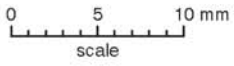
R_L = Load resistor; see AC electrical characteristics for value.
C_L = Load capacitance includes jig and probe capacitance; see AC electrical characteristics for value.
R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

family	INPUT PULSE REQUIREMENTS					
	amplitude	V_M	rep. rate	t_w	t_{TLH}	t_{THL}
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns

SF00777

DIP24: plastic dual in-line package; 24 leads (300 mil) **SOT222-1**





DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

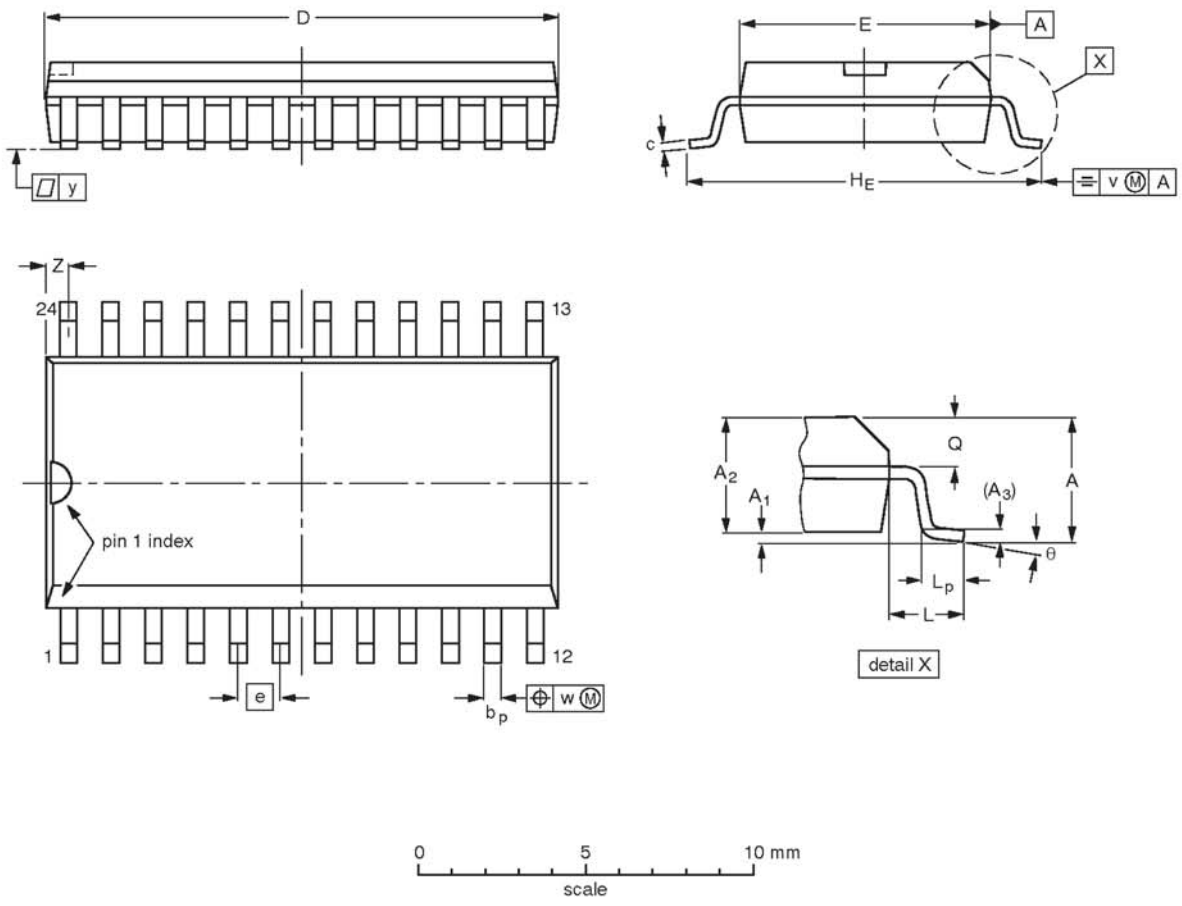
UNIT	A max.	A_1 min.	A_2 max.	b	b_1	c	$D^{(1)}$	$E^{(1)}$	e	e_1	L	M_E	M_H	w	$Z^{(1)}$ max.
mm	4.70	0.38	3.94	1.63 1.14	0.56 0.43	0.36 0.25	31.9 31.5	6.73 6.48	2.54	7.62	3.51 3.05	8.13 7.62	10.03 7.62	0.25	2.05
inches	0.185	0.015	0.155	0.064 0.045	0.022 0.017	0.014 0.010	1.256 1.240	0.265 0.255	0.100	0.300	0.138 0.120	0.32 0.30	0.395 0.300	0.01	0.081

Note

1. Plastic or metal protrusions of 0.01 inches maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT222-1		MS-001AF				95-03-11

SO24: plastic small outline package; 24 leads; body width 7.5 mm **SOT137-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	15.6 15.2	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.61 0.60	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT137-1	075E05	MS-013AD				~~95-01-24~~ 97-05-22